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(54) Electrically conductive, anti-reflection coating

(57) Anti-reflective, electrically conductive coating, having a two-layer structure comprising a transparent outer layer (2) made of either Silicon oxide (SiO₂) or Magnesium Fluoride (MgF₂) and an electrically conductive, light absorbing inner layer (1) made of one of Titanium nitride TiN_x, Titanium nitride including tungsten impurities TiN_x-(W), Titanium oxynitride TiN_xO_y, Zirconium nitride ZrN_x, Zirconium oxynitride ZrN_xO_y, a mixing of TiN_xO_y and ZrN_xO_y, or Indium tin oxide including Gold ITO-(Au).

The outer and inner layers have a thickness of about 80 nm and 10 nm, respectively. One coating embodiment has an electrical sheet resistance of 237 ohms/square. Reflection coefficients lower than about 0.4% over the visible spectral range are achieved.

The coating can be applied on a substrate (11) made of glass or polyethylene terephthalate (PET) covered with a hart acrylic resin (12), e.g. on a CRT screen.

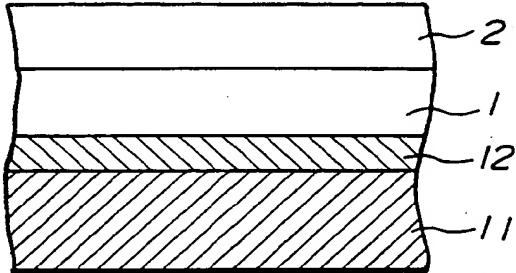


FIG.1B

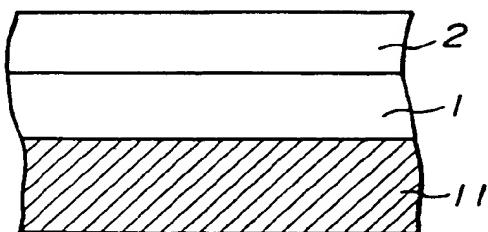


FIG.1A

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Description**BACKGROUND OF THE INVENTION**

5 This invention relates to an anti-reflection film as an optical film deposited on a supporting layer and configured for having anti-reflection properties and for preventing leakage of elector-magnetic waves or accumulation of static charges.

DESCRIPTION OF RELATED ART

10 Up to now, an anti-reflection film has been extensively used in the field of optical or octo-electrical application where it is desired or necessary to decrease the refractive index on an optical boundary between, for example, air and glass. Examples of such application include a camera lens, a platen for a copying machine, a cover glass for equipment, a panel for a cathode-ray tube and other display devices.

15 Among optical thin-film coatings, employed in a variety of application fields, there are a sole coating layer of a film composed of magnesium fluoride, a dual layer coating which minimizes the refractive index in a wavelength range, and a multi-layer broad-range coating producing a low refractive index over a broader wavelength range, such as a visible range.

The dual-layer coating is now explained.

20 A dual-layer anti-reflection film, as disclosed in US Patent No.4422721 (anti-reflection film A), is made up of at least one layer of a low refractive index material, such as magnesium fluoride, a thin transparent layer of an electrically conductive high refractive index material, such as indium tin oxide (INTO), cadmium stannate or tin antimony oxide. This dual-layer anti-reflection film is made up of the layer of low refractive index material and the thin transparent layer of the electrically conductive high refractive index material, deposited in this order on the surface of an optical substrate. The 25 layer of the electrically conductive material has an optical thickness of 1.0 to 30.0 nm, while the layer of the low refractive index material has a film thickness correlated with the thickness of the layer of the electrically conductive material for prohibiting deterioration of the layer of the electrically conductive material.

The dual-layer anti-reflection film A, made up of a film of low refractive index material and a high refractive index material, provides a directly electrically connectable electrically conductive anti-reflection film which may be used with 30 advantage for a CRT or a copying machine.

An dual-layer anti-reflection film, disclosed in US Patent No.4732454 (anti-reflection film B), is made up of a transparent substrate of a synthetic material, a hard scratch-proof first layer deposited on the substrate, a second layer of an electrically conductive material, intimately affixed to the first layer and formed by vacuum deposition or sputtering by high frequency discharge at a temperature lower than 150° C in the presence of oxygen atoms and a third layer formed 35 of a material having a lower refractive index than that of the second layer and intimately affixed to the second layer. The second layer is comprised of INTO as its ingredient.

The anti-reflection film B can propagate light and can be coated on a protective layer of a synthetic material so as to serve as an anti-reflection film suitable as a filter with respect to elector-magnetic waves emanating from the CRT filter.

40 The above anti-reflection film A leaves much to be desired in that it is lower in electrical conductivity and in reflection inhibiting ratio over a wide frequency range.

Similarly to the anti-reflection film A, the above anti-reflection film B leaves much to be desired in that it is lower in reflection inhibiting ratio over a wide frequency range.

If the anti-reflection film low in electrical conductivity is attached to a panel for CRT, it has only little effect in preventing static charges or inhibiting an output of elector-magnetic waves from being outputted from a CRT panel.

SUMMARY OF THE INVENTION

50 It is therefore an object of the present invention to provide an anti-reflection film having high electrical conductivity and high reflection inhibiting ratio in a broad frequency range.

An anti-reflection film according to the present invention has two mutually neighboring layers which are deposited directly or via a hard coating layer on a supporting layer. One of the layers that is closer to a substrate layer is formed of an electrically conductive material capable of absorbing light, while the remaining second layer is formed of a material having a refractive index not higher than 2.0. If the first layer has the refractive index and the extinction coefficient for a 55 shorter wavelength λ_v of n_v and k_v , respectively, and the refractive index and the extinction coefficient for a longer wavelength λ_r of n_r and k_r , respectively, n_v is larger than n_r and k_v is smaller than k_r ($n_v > n_r$ and $k_v < k_r$).

If the first layer is generated in the presence of oxygen with an oxygen partial pressure of not more than 50%, the amount of generation of oxides may be reduced for reducing deterioration in electrical conductivity.

According to the present invention, there is provided an anti-reflection film having high electrical conductivity and

high anti-reflection effect over a wide frequency range despite its simplified structure, thus prohibiting static charges or elector-magnetic waves from being outputted from an optical substrate on which is affixed the anti-reflection film.

BRIEF DESCRIPTION OF THE DRAWINGS

5 Fig.1 illustrates essential portions of an anti-reflection film embodying the present invention.

Fig.2 is a graph showing an example of an admittance diagram for illustrating the selecting principle of the first layer of the anti-reflection film shown in Fig.1.

10 Fig.3 is a graph showing an admittance diagram of a conventional TiO_2 - SiO_2 anti-reflection film.

Fig.4 is a graph showing an admittance diagram of an $INTO/Au$ - SiO_2 anti-reflection film embodying the present invention.

15 Fig.5 is a graph showing the relation between the refractive index or the extinction coefficient of the first layer of the anti-reflection film and the wavelength.

Fig.6 is a graph showing an admittance diagram for the wavelength λ of 405 nm of a $TiN_x(W)$ - SiO_2 anti-reflection film embodying the present invention.

20 Fig.7 is a graph showing an admittance diagram for the wavelength λ of 546 nm of the $TiN_x(W)$ - SiO_2 anti-reflection film shown in Fig.6.

Fig.8 is a graph showing an admittance diagram for the wavelength λ of 633 nm of the $TiN_x(W)$ - SiO_2 anti-reflection film shown in Fig.6.

25 Fig.9 is a graph showing an admittance diagram for the wavelength λ of 405 nm of a ZrN_xO_y - SiO_2 anti-reflection film embodying the present invention.

Fig.10 is a graph showing an admittance diagram for the wavelength λ of 633 nm of the ZrN_xO_y - SiO_2 anti-reflection film shown in Fig.9.

30 Fig.11 is a graph showing the reflectance of the TiN_x - SiO_2 anti-reflection film embodying the present invention, as found by calculations.

Fig.12 is a graph showing the transmittance of the TiN_x - SiO_2 anti-reflection film of Fig.11, as found by calculations.

Fig.13 is a graph showing the reflectance of the TiN_x - SiO_2 anti-reflection film of Fig.11, as found by measurements.

35 Fig.14 is a graph for illustrating the relation between the reflectance and a distance between the refractive index/extinction coefficient on the low range side and the refractive index/extinction coefficient on the high range side for the anti-reflection film according to the present invention.

Fig.15 is a graph showing the reflectance of the $TiN_x(W)$ - SiO_2 anti-reflection film embodying the invention.

Fig.16 is a graph showing the transmittance of the $TiN_x(W)$ - SiO_2 anti-reflection film of Fig.15 the wavelength, as found by calculations.

40 Fig.17 is a graph showing the reflectance of the $TiN_x(W)$ - SiO_2 anti-reflection film of Fig.15, as found by measurements.

Fig.18 schematically shows an example of application of the anti-reflection film embodying the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

40 Referring to the drawings, preferred embodiments of the present invention will be explained in detail.

The anti-reflection film is directly deposited on the surface of an optical substrate for diminishing the amount of the reflected light from the optical substrate surface and exhibits electrical conductivity on the surface of the optical substrate. Also, the anti-reflection film is deposited on a flexible supporting layer of, for example, polyethylene terephthalate (PET) so as to serve as an anti-reflection film sheet which is bonded on a display surface, such as glass surface, of a display apparatus comprised of a cathode ray tube (CRT). Alternatively, the anti-reflection film is directly deposited on the display surface at the time of manufacture of the CRT of the display apparatus for suppressing the glaring reflected light from the display surface or suppressing emission of elector-magnetic waves or static charges to a minimum. In addition, since only two thin-film layers suffice, the anti-reflection film takes only a small amount of material and can be furnished at a low cost.

45 The anti-reflection film of the present invention has two features, namely that it exhibits anti-reflection characteristics using a light-absorbing material with the refractive index n and the extinction coefficient k , and that optical characteristics in the wavelength range are thereby broadened thus enabling a broader wavelength range for the anti-refection film with a smaller number of component films than with the conventional multi-layer film.

50 The above-mentioned flexible supporting layer is used as a supporting layer 11, and the anti-reflective film is made up of a first layer 1 and a second layer 2, looking from the side closer to the supporting layer 11, as shown in Fig.1A. Alternatively, a hard coating, or a hard coat layer 12, is first formed on the supporting layer 11, and a first layer 1 is formed on the hard coat layer 12, as shown in Fig.1B.

55 Among the conditions of selecting the first layer 1 are low cost, high adhesion to the surface of the optical substrate, high durability, low stress, and an adjustable optimum refractive index n or extinction coefficient k . Among the condi-

tions of selecting the second layer 2 are low cost, low refractive index, low stress, hardness and high durability.

As a principle of the present embodiment, optimum optical characteristics will be explained using the principle of the admittance diagram.

The optical admittance is generally given as a complex number. If units are selected appropriately, the real part may be numerically equated to the refractive index n of the space or a substance allowing passage of light, while the imaginary part may be numerically equated to the extinction coefficient of the above space or the substance.

In addition, each point representing admittance follows the admittance diagram as later explained, and is characteristic of the substance employed, while being dependent on the thickness of the substance traversed by light.

Fig.2 shows an admittance diagram of TiN_x and SiO_2 on a glass substrate as later explained. In Fig.2, n_v and k_v denote the refractive index and extinction coefficient for a wavelength $\lambda = 450$ nm, respectively, while n_r and k_r denote the refractive index and extinction coefficient for a wavelength $\lambda = 650$ nm. The loci of movement of the admittance values pass through a point (1.52, 0) on the glass substrate on the real axis so as to be converged with increased film thickness at points $(n_v, -k_v)$, $(n_r, -k_r)$.

For TiN_x , a curve 21 passing through points $(-n_v, k_v)$ and $(n_v, -k_v)$ and the aforementioned pre-set point (1.52, 0) represents the above admittance diagram for w wavelength $\lambda = 450$ nm. On the other hand, a curve 22 passing through points $(-n_r, k_r)$ and $(n_r, -k_r)$ and the aforementioned pre-set point (1.52, 0) represents the above admittance diagram for w wavelength $\lambda = 650$ nm.

On the other hand, the admittance diagram for SiO_2 is obtained as a curve 23 which is a circle with a radius of 0.56 and with a center at $((1.46^2 + 1)/2, 0) = (1.56, 0)$.

In forming a dual-layer film, the locus of movement of the admittance may be formed by combining curves 21, 22 and 23.

Fig.3 shows an admittance diagram of an anti-reflection film in which the first layer is a film of titanium dioxide (TiO_2) and the second layer is a film of silicon dioxide (SiO_2) termed a V-coat. Meanwhile, TiO_2 is higher in refractive index, while SiO_2 is lower in refractive index and larger in film thickness than TiO_2 .

Fig.3 shows an admittance diagram of the anti-reflection film of the dual-layer film (TiO_2-SiO_2) for incident visible light beams with wavelength λ of 450 nm, 550 nm and 650 nm. For example, for the wavelength $\lambda = 450$ nm, the locus of movement when the light passes through TiO_2 is denoted by the locus of movement beginning at near $n = 1.52$ and ending at a point a lying at a one-o'clock position, while the locus of admittance when the light passes through SiO_2 is denoted by an arc locus of movement beginning from the point a and ending at a point a' lying at a 10-o'clock position.

For the wavelength $\lambda = 550$ nm, the locus of movement when the light passes through TiO_2 is denoted by the locus of movement beginning at a starting point and ending at a point b, while the locus of admittance when the light passes through SiO_2 is denoted by a locus of movement beginning from the point b and ending at a point b'. Similarly, for the wavelength $\lambda = 650$ nm, the locus of movement when the light passes through TiO_2 is denoted by the locus of movement beginning at a starting point and ending at a point c while the locus of movement of admittance when the light passes through SiO_2 is denoted by a locus of movement beginning from the point c and ending at a point c'.

As may be seen from the admittance diagrams of the (TiO_2-SiO_2) anti-reflection film, since the distance of movement of the locus of movement of the admittance when the light passes through the first and second films differs with the wavelength λ of the incident light, the coordinates of the end points a', b' and c' of the respective loci of movement are not constant. From this it may be said that, if the wavelength of the incident light is varied, the optical film thickness QWOT (quarter wave of optical thickness; an optical thickness represented with $\lambda/4$ as a unit) of the TiO_2-SiO_2 is changed. That is, if the light having a wavelength from 450 to 650 nm is incident, it may be predicted that there exists reflected light depending on the wavelength, with the light volume being correspondingly changed.

In this respect, it is difficult with the anti-reflection film made up of the dual-layer film to prevent reflection of light of a broad wavelength range, such that improvement is desired.

In an embodiment of the present invention, the above-mentioned first layer is made up of indium tin oxide (INTO) and gold (Au) and the second film is formed of SiO_2 . Fig.4 shows an admittance diagram of this INTO/Au- SiO_2 anti-reflection film. The first layer is constituted so that the refractive index n_{11} of INTO and the refractive index n_{12} of gold Au account for 60% and 40%, respectively, of the refractive index of the first layer, that is so that the refractive index n_1 of the first layer is $n_1 = 0.6n_{11} + 0.4n_{12}$. The first layer has a film thickness of, for example, 12.8 nm, while the second layer has a film thickness of, for example, 77.8 nm.

The method of finding the admittance diagram is now explained. In a multi-layer film, the effect of the respective layers is represented by the following equation (1):

5

$$\begin{array}{|c|c|} \hline \kappa & \kappa \\ \hline \kappa & \kappa \\ \hline \end{array}$$

10

... (1)

where $\delta = 2\pi N d \cos \theta / \lambda$.

In the above equation (1), N in the equation for δ ($\delta = 2\pi N d \cos \theta / \lambda$) denotes complex refractive index and is represented by $N = n - ik$ where n and k represent the refractive index and the extinction coefficient of each layer, where i is an unit of an imaginary number, with $i^2 = -1$. That is, N is a value corresponding to the optical admittance y . On the other hand, θ is an angle of incidence which becomes equal to zero for vertical incident light ($\theta = 0$), while d denotes a film thickness.

For obtaining the combined admittance of the multi-layer film in its entirety, calculations of the following equation (2):

20

$$\begin{vmatrix} B \\ C \end{vmatrix} = I \cdot \prod_{h=1}^g \begin{vmatrix} \cos \kappa_h (i \sin \kappa_h) y_h \\ i y_h \sin \kappa_h \cos \kappa_h \end{vmatrix} \prod_{h=g+1}^m \begin{vmatrix} 1 \\ y_m \end{vmatrix}$$

25

... (2)

30

are performed.

In the equation (2), y_m denotes the admittance of the substrate. The combined optical admittance or combined admittance is found by $Y = C/B$.

Returning to the anti-reflection film of the dual-layer film (ITO/Au-SiO₂), the ITO-Au layer constituting the first layer is a metal layer with a gold color admixed with an electrically conductive oxide and which exhibits different light absorption depending on the wavelength λ of the incident light. The admittance describes loci of movement different as far as the points d , e and f for the wavelengths $\lambda = 450$ nm, 550 nm and 650 nm, as shown in Fig.4. The points d , e and f are located at respective different positions and are varied depending on physical properties of the first layer, such as the type of the materials used for the first layer or the thickness of the first layer, or the wavelength of the light incident on the first layer.

The locus of movement of the admittance of the SiO₂ layer are from the points d , e and f to the point g . The point g is (1, 0), from which it is seen that the (ITO/Au-SiO₂) anti-reflection film has an admittance which goes to 1, that is, completely inhibits reflection, no matter which wavelength range of at least the visible light is incident thereon.

By arranging this first layer as the light absorbing layer, and by determining the physical properties of the first layer based on the admittance diagram of the second layer, an anti-reflection film is realized which is made up only of the first and second layers and which substantially completely prohibits reflection of light in the visible range.

If the conditions of the materials constituting the first layer are selected so that the admittance diagram shown in Fig.2 can be delineated, that is if the shorter wavelength side and the longer wavelength side of selected two wavelengths are denoted as wavelength λ_v and λ_r , and if, in the above first layer, the refractive index and the extinction coefficient for the wavelength λ_v are denoted as n_v and k_v , respectively, while the refractive index and the extinction coefficient for the wavelength λ_r are denoted as n_r and k_r , respectively, the relation between the wavelength λ and the refractive index n is represented by a straight line having a negative gradient, as shown for example at A in Fig.5, while the relation between the wavelength λ and the extinction coefficient k is represented by a straight line having a positive gradient, as shown for example at B in Fig.5. That is, the following inequalities (3):

55

$$n_v > n_r \text{ and } k_v < n_r \quad (3)$$

are met.

The relation between the wavelength λ and the refractive index n and that between the wavelength λ and the extinc-

tion coefficient k need not be linear as shown at A and B in Fig.5, it being only sufficient if the relation of the inequalities (3) are met.

Among other materials satisfying the inequalities (3) are gold (Au), copper (Cu) and titanium nitrides (TiN_x), where $x > 0$.

5

TABLE 1

		refractive index [n]	quenching coefficient [k]
Au	450 nm	$n_v = 1.4$	$k_v = 1.9$
	650 nm	$n_r = 0.15$	$k_r = 3.2$
Cu	450 nm	$n_v = 1.2$	$k_v = 2.4$
	650 nm	$n_r = 0.21$	$k_r = 3.7$
TiN_x	450 nm	$n_v = 2.4$	$k_v = 1.2$
	650 nm	$n_r = 1.7$	$k_r = 1.8$

20

The first layer may be constituted by a titanium nitride (TiN_x), zirconium nitride (ZrN_x) and a mixture of titanium nitride and zirconium nitride, where $x > 0$.

The first layer may also be constituted by at least one of titanium oxynitrides (TiN_xO_y), zirconium oxynitrides (ZrN_xO_y) and a mixture of titanium oxynitrides (TiN_xO_y) and zirconium oxynitrides (ZrN_xO_y), where $x > 0$ and $y > 0$.

As a modification of the present invention, an anti-reflection film of a dual-layer film ($TiN_x(W)$ - SiO_2), employing a film of titanium nitride ($TiN_x(W)$), having tungsten (W) introduced therein as impurities, as the first layer, and also employing a film of SiO_2 as the second layer, is now explained by referring to the drawings. For the first layer, preferably $0 < x \leq 1$. Figs.6 to 9 are admittance diagrams of the anti-reflection film comprised of the dual-layer film ($TiN_x(W)$ - SiO_2).

As for the first layer ($TiN_x(W)$), the proportion of tungsten W to titanium Ti is set to 0.6 atom % by carrying out sputtering with tungsten (W) bonded on titanium Ti used as a target. The value of x is set by setting the partial pressure values of argon Ar and nitrogen N_2 in a flow gas used for forming the first layer by sputtering so as to be 87% and 13%, respectively, for example.

Figs.6 to 8 illustrate the cases in which the incident visible light beams have different wavelength values λ . That is, Figs.6, 7 and 8 illustrate admittance diagrams for $\lambda = 405$ nm, $\lambda = 546$ nm and $\lambda = 633$ nm, respectively. The anti-reflection film constituted by this dual-layer film $TiN_x(W)$ - SiO_2 is made up of the first layer $TiN_x(W)$ with a film thickness of 9.93 nm and the second layer SiO_2 with a film thickness of 82.81 nm sequentially deposited on a glass substrate having a refractive index $n_0 = 1.52$ and the extinction coefficient $k_0 = 0$. If $\lambda = 405$ nm in Fig.6, the refractive index n_1 and the extinction coefficient k_1 of the first layer are 2.5 and 0.73, respectively, whereas, if $\lambda = 546$ nm in Fig.7, the refractive index n_1 and the extinction coefficient k_1 of the first layer are 1.58 and 1.49, respectively and, if $\lambda = 633$ nm in Fig.8, the refractive index n_1 and the extinction coefficient k_1 of the first layer are 1.16 and 1.74, respectively. As for the second layer, the refractive index n_2 and the extinction coefficient k_2 of the first layer are 1.45 and 0, respectively, without regard to the wavelength. In Figs.6 to 8, curves from point a to point b represent the loci of movement of the admittance when the light passes through the first layer $TiN_x(W)$, while curves from point b to point c represent the loci of movement of the admittance when the light passes through the second layer SiO_2 .

In Figs.6 to 8, the reflectance R is 0.48%, 0.015% and 0.014% for the incident light wavelength λ of 405 nm (Fig.6), 546 nm (Fig.7) and 633 nm (Fig.8), respectively. That is, reflectance R is suppressed to a lower value without regard to the wavelength range of the incident visible light.

In the present modification, by using a light absorbing layer as a first layer and by determining the physical properties of the first layer based on the admittance type of the second layer, an anti-reflection film is realized which is made up of the first layer and the second layer and which substantially completely inhibits reflection of the visible range light.

As a further modification, a dual-layer anti-reflection ZrN_xO_y - SiO_2 film made up of a first layer of zirconium oxynitride ZrN_xO_y and a second layer of SiO_2 is explained by referring to admittance diagrams of Figs.9 and 10. The first layer ZrN_xO_y , where $0 < x \leq 1$ and $0 < y \leq 2$, is formed of a material having optical properties, which are now explained.

Figs.9 and 10 show admittance diagrams for $\lambda = 405$ nm and for $\lambda = 633$ nm, respectively. In the present modification, the first layer (ZrN_xO_y) and the second layer SiO_2 are deposited respectively on a glass substrate with the refractive index n_0 of 1.52 and the extinction coefficient k_0 of zero, to film thicknesses of 9.59 nm and 90.37 nm, respectively. For $\lambda = 405$ nm of Fig.9, the refractive index n_1 and the extinction coefficient k_1 of the first layer are 2.4 and 0.4, respec-

tively, whereas, for $\lambda = 633$ nm of Fig.10, the refractive index n_1 and the extinction coefficient k_1 of the first layer are 1.72 and 1.75, respectively. As for the second layer, the refractive index n_2 and the extinction coefficient k_2 are 1.45 and zero, respectively, regardless of the wavelength. In Figs.9 and 10, curves from point a to point b represent the loci of movement of the admittance when the light passes through the first layer ZrN_xO_y , while curves from point b to point c represent the loci of movement of the admittance when the light passes through the second layer SiO_2 .

In Figs.9 and 10, the reflectance R is 0.39% and 0.081% for the incident light wavelength λ of 405 nm (Fig.9) and 636 nm (Fig.10), respectively. That is, reflectance R is suppressed to a lower value without regard to the wavelength range of the incident visible light.

An embodiment of a dual-layer anti-reflection film TiN_x-SiO_2 employing a titanium nitride TiN_x and silicon dioxide

SiO_2 as the first and second layers, respectively, is now explained.

Titanium nitride TiN_x has a refractive index n_v and an extinction coefficient k_v of 2.4 and 1.2 for the light with the wavelength of 450 nm, and a refractive index n_r and an extinction coefficient k_r of 1.7 and 1.8 for the light with the wavelength of 650 nm, as shown in Table 1, and has an admittance diagram as shown in Fig.2.

On the other hand, if titanium oxide is present in admixture in TiN_x , the latter is lowered in electrical conductivity, while it is difficult to produce a stabilized system completely freed of oxygen in order to form TiN_x industrially. Therefore, TiN_x employed in the present modification is produced in the presence of oxygen, with the oxygen partial pressure being not higher than 50%.

Fig.11 shows the relation between the wavelength nm of the dual-layer TiN_x-SiO_2 anti-reflection film and the reflectance (%) based on calculated results, while Fig.12 shows the relation between the wavelength nm and transmittance (%) based on calculated results. Although a variety of equations have been known for finding the reflectance and transmittance, basically the reflectance R for the wavelength λ and the transmittance T for the wavelength λ may be found by the following equations (4) and (5):

$$25 \quad R = \left| \frac{y_0 B - C}{y_0 B + C} \right| \Pi \left| \frac{y_0 B - C}{y_0 B + C} \right| \Pi^* \quad (4)$$

$$30 \quad T = \frac{4y_0 Re(\pi_m)}{(y_0 B + C)(y_0 B + C)^*} \quad (5)$$

respectively.

35 In these equations (4) and (5), B and C may be found from the equation (2) and, for a dual-layer film, may be found from the following equation (6):

$$40 \quad \begin{vmatrix} B \\ C \end{vmatrix} = \begin{vmatrix} \cos \kappa_2 & i \sin \kappa_2 / y_2 \\ i y_2 \sin \kappa_2 & \cos \kappa_2 \end{vmatrix} \begin{vmatrix} \cos \kappa_1 & i \sin \kappa_1 / y_1 \\ i y_1 \sin \kappa_1 & \cos \kappa_1 \end{vmatrix} \begin{vmatrix} 1 \\ y_m \end{vmatrix}$$

45 . . . (6)

50 In the equation (6), $\delta = 2\pi N d \cos \theta / \lambda$. For the present calculations, $\theta = 0$. The complex refractive index n_2 of the second layer is 1.45, which corresponds to y_2 . The complex refractive index N_1 of the first layer is $n_1 - ik_1$, which corresponds to y_1 . The optical admittance of the substrate is y_m , which is 1.52 for the glass substrate.

55 The film thickness for which the reflectance with the incident light wavelength on the short wavelength side becomes equal to zero is now derived. The film thicknesses of the first and second films are defined as d_1 and d_2 , respectively.

The condition under which the reflectance becomes equal to zero is shown by the equation (7):

$$Y(d_1, d_2) = C_2 / B_2 = 1 \quad (7)$$

wherein d_1 , d_2 are film thicknesses of the first and second layers, respectively, while C_2 , B_2 are found by substituting $C = C_2$, $B = B_2$ into the equation (6). The angle δ_1 of the first layer and the angle δ_2 of the second layer are represented by the following equations (8) and (9):

$$5 \quad \delta_1 = 2\pi y_1 d_1 / \lambda \quad (8)$$

$$10 \quad \delta_2 = 2\pi y_2 d_2 / \lambda \quad (9)$$

10 In the embodiments of Figs.11 and 12, the structure shown at B in Fig.1 is presupposed. That is, an acrylic resin functioning as a hard coating layer 12 is coated to a thickness of approximately 6 nm on a polyethylene terephthalate (PET) film, with a thickness of 188 nm, functioning as a supporting layer 11, and a TiN_x operating as the first layer 1 and SiO_2 operating as the second layer 2 are deposited to a thickness of 10 nm and 80 nm, respectively.

15 In Fig.11, reflectance R (%) for the wavelength λ (nm) is found for 100 samples having a thickness conforming to Gaussian distribution at 1σ of 2% with respect to the above thickness in consideration of thickness fluctuations of the TiN_x at the time of manufacture in order to find an upper limit value, a lower limit value and a mean value, which are indicated as an upper limit value curve 31, a mean value curve 32 and a lower limit value curve 33, respectively. Fig.11 shows a design margin in which, if the thickness of the TiN_x and SiO_2 layers are fluctuated on the order of 2% at the time of manufacture, the optical properties of the anti-reflection film are confined in a range between the upper limit value curve 31 and the lower limit value curve 33. The mean value curve 32 exhibits ripple caused by light interference 20 from the hard coating layer.

20 In Fig.12, the light transmittance assumes different values depending on the thickness of the TiN_x layer, as in Fig.11. Thus, Fig. 12 shows an upper limit value curve 41, a mean value curve 42 and a lower limit value curve 43 in the Gaussian distribution for 100 samples with 1σ equal to 2% thickness variation.

25 Figs.11 and 12 indicate that the (TiN_x-SiO_2) anti-reflection film may be satisfactorily applied as a reflection inhibiting film for a CRT for which a drastically low reflectance or a drastically flat wavelength to light transmittance curve are not required, and that an anti-reflection film for CRT may be realized by a dual-layer film.

30 Fig.13 shows the relation between the wavelength (nm) and the reflectance (%) of the (TiN_x-SiO_2) anti-reflection film, as found by measurements. It is seen from Fig.13 that, since a curve similar to one given by the above calculated values has been obtained, the (TiN_x-SiO_2) anti-reflection film represents a desirable embodiment. Moreover, the sheet resistance of the TiN_x layer is 237 ohms/square, which is a value about one-fourth the typical sheet resistance value of 1000 ohms/square capable of suppressing elector-magnetic waves liable to be produced from the front surface of the CRT, meaning that an improved shielding anti-reflection film may be produced.

35 The range of practical utilization of the anti-reflection film is checked from the relation shown in equation 3. For this checking, the following relationships shown by the equations (10) and (11):

$$n_v > n_r + D \quad (10)$$

$$40 \quad k_v > k_r + D \quad (11)$$

40 are used. In these equations (10) and (11), "D" denotes the distance between n_v and n_r or the distance between k_v and k_r . Fig.14 shows the relation between D and calculated average values of reflectance. If, with the refractive index n_v and the extinction coefficient k_v at short the wavelength λ_v , the refractive index n_r for the long wavelength λ_r is assumed to be $n_v - D$, while the extinction coefficient k_r is assumed to be $k_v + D$. Some values of each of n_v , k_v and D are selected in order to find reflectance and a mean value is found for the same value of D.

45 , if $\lambda_v = 450$ nm, $\lambda_r = 650$ nm, the refractive index n_v at the wavelength λ_v is set to 0.7, 1.5 and 2.5, the extinction coefficient k_v is 1.0 and 4.0, and D is set to 0.2 for each of the refractive index n_v and the extinction coefficient k_v for the short wavelength, the refractive index n_r for the long wavelength is 0.5, 1.3 and 2.2 from $n_v - 0.2$, while the extinction coefficient k_r is 1.2 and 4.2 from $k_v + 0.2$. By finding the reflectance for the six sets of combinations and finding an average value, the mean reflectance 0.28 for $D = 0.2$ may be found. Similarly, the mean reflectance 0.19 for $D = 0.4$ and the mean reflectance 0.13 for $D = 0.6$ are found. Fig.14 shows the relation between D and the reflectance thus found.

50 Fig.14 shows that, if the reflectance suppressing effect of not more than 0.2 is the range of practical utilization of the anti-reflection film, it is most useful in demonstrating the effect of the present invention to constitute the first layer of the anti-reflection film by a film having a value of D larger than 0.4, that is by a film having the refractive index n and the extinction coefficient k satisfying the equations (12) and (13):

$$55 \quad n_v > n_r + 0.4 \quad (12)$$

$$k_v > k_r + 0.4 \quad (13)$$

That is, it suffices to design the dual-layer film by setting the refractive index n_v and the extinction coefficient k_v on the short wavelength side and the refractive index n_r and the extinction coefficient k_r on the long wavelength side for satisfying the above condition.

With the above structure of the anti-reflection film, high electrical conductivity and high anti-reflection effect may be realized over a wide frequency range despite the simplified structure of the dual film, thus prohibiting static charges or elector-magnetic waves from being outputted from an optical substrate on which is affixed the anti-reflection film.

Referring to Figs.15 to 17, the optical properties of a dual-layer anti-reflection film of $TiN_x(W)$ - SiO_2 , having a film of titanium nitride having tungsten W introduced as impurities, as a first layer, and also having a film of SiO_2 as a second layer, will now be explained. In the present embodiment, the dual-layer film is deposited via a hard coat layer of an acrylic resin on a polyethylene terephthalate (PET) substrate. The optical properties of the PET layer include the refractive index n of 1.50, 1.48, 1.46, 1.47, 1.48 and 1.50 for the wavelengths λ of 400 nm, 430 nm, 550 nm, 650 nm, 700 nm and 750 nm, respectively, with the extinction coefficient k being zero for all of the wavelengths. The first layer $TiN_x(W)$ has a refractive index n of 2.50 and an extinction coefficient k of 0.73 for the thickness of 9.72 nm and the wavelength $\lambda = 405$ nm, with $n = 1.155$ and $k = 1.735$ for $\lambda = 632.8$ nm. As for the second layer of SiO_2 , $n = 1.45$ and $k = 0$ for the thickness of 84.28 nm and the wavelength $\lambda = 546$ nm.

Fig.15 shows values of the reflectance R versus the incident light wavelength λ , as calculated from the equation (4). Fig.16 shows the calculated values as found from the equation (5).

Fig.17 shows the measured values of the reflectance R versus the wavelength λ of the dual-layer anti-reflection film as tentatively produced under the above conditions. Fig.17 shows that a dual-layer film obtained by doping TiN_x with tungsten is effective to prevent reflection of light over a wide frequency range of from approximately 450 nm to 680 nm.

By adjusting the film thickness, blue reflected light can be accentuated, while red reflected light can be attenuated. This indicates that, if the dual-layer film is used as an anti-reflection film, the reflected light from the CRT display can be white slightly tinted with blue or purple. Such reflected colors are commonly desirable for CRT display purposes.

With the above construction of the anti-reflection film, an anti-reflection film may be provided which, despite its simple dual-layer construction, is high in electrical conductivity and in anti-refection ratio over a wide frequency range, and has an improved effect in preventing static charges or elector-magnetic waves from being outputted from the surface of the optical substrate, such as a CRT.

Fig.18 shows an instance in which the above-described dual-layer anti-reflection film is applied on a CRT 51. Referring to Fig.18, there is formed on a glass plate on the display surface of the CRT 51 a PET film 53 via a UV-cured resin 52, and an anti-reflection film 55 formed by the above-described dual-layer film is applied via a hard coat layer 54 on the PET film 53. An anti-contamination coating layer 56 is deposited, if need be, on the anti-reflection film 55. It is possible with such structure to suppress the reflected light 57 on the screen surface substantially to zero and preventing an elector-magnetic wave 58 from being radiated from the inside of the CRT. By electrically grounding an electrically conductive layer of the anti-reflection film 55 by an grounding wire 59, static charges may be inhibited, while the elector-magnetic wave shielding effect may be improved further.

Although an anti-reflection film is applied to a PET film and the resulting assembly is tightly affixed to the surface of the display device so as to be used as an anti-reflection film for the CRT surface, this is not limitative of the present invention. For example, the anti-reflection film may be directly applied to the CRT surface, while the film may be used for the surface of the optical substrate, such as a platen of a copying machine or a cover glass for an equipment. The anti-reflection film may be transiently applied to the surface of the PET film which is then intimately affixed to the surface of the optical substrate, or the anti-reflection film may be directly deposited on the optical substrate surface.

Although the PET film is used in the above embodiments as a supporting layer, this is not limitative and a vitreous supporting layer may also be employed.

Although an INTO-Au layer is used in the above embodiment as a first layer, that is as a layer of a metal material admixed with an electrically conductive oxide, this is not limitative and a metal material admixed with another electrically conductive oxide may also be employed.

In addition, although the second layer is a layer of silicon dioxide in the above embodiment, this again is not limitative and a material having a refractive index of not more than 2.0, such as magnesium difluoride MgF_2 with a refractive index $n = 1.38$, may also be employed for achieving the results of the present invention.

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Claims

1. An anti-reflection film deposited on a supporting layer comprising: two mutually neighboring layers, that is a first layer and a second layer as counted beginning from the supporting layer, said first layer being formed of an electrically conductive material absorbing the light and said second layer being formed of a material having a refractive index not higher than 2.0, wherein, if an arbitrarily selected shorter wavelength is λ_v , an arbitrarily selected longer wavelength is λ_r , the refractive index and the extinction coefficient for the wavelength λ_v of said first layer are n_v and k_v , respectively, and the refractive index and the extinction coefficient for the wavelength λ_r of said second layer are n_r and k_r , respectively, n_v is larger than n_r and k_v is smaller than k_r . The anti-reflection property is present at wave-

length λ_v and λ_r and points in between λ_v and λ_r

2. The anti-reflection film as claimed in claim 1 wherein said first layer is deposited on a supporting layer of a plastic material.
- 5 3. The anti-reflection film as claimed in claim 1 wherein said first layer is deposited on hard coat layer deposited in turn on a supporting layer of a plastic material.
- 10 4. The anti-reflection film as claimed in claim 1 wherein said first layer is a layer generated in the presence of oxygen having an oxygen partial pressure of not higher than 50%.
- 15 5. The anti-reflection film as claimed in claim 1 wherein said first layer is formed of a metal material admixed with an electrically conductive oxide.
6. The anti-reflection film as claimed in claim 1 wherein said first layer is formed of titanium nitride.
7. The anti-reflection film as claimed in claim 1 wherein said first layer is formed of a titanium nitride admixed with tungsten as impurities.
- 20 8. The anti-reflection film as claimed in claim 1 wherein said first layer is formed of zirconium oxynitride.
9. The anti-reflection film as claimed in claim 1 wherein said second layer is formed of silicon dioxide.
- 25 10. The anti-reflection film as claimed in claim 1 wherein n_v of said first layer is larger than $(n_r + 0.4)$ and k_v is larger than $(k_r + 0.4)$.

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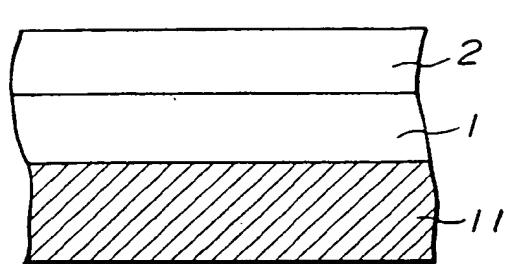


FIG.1A

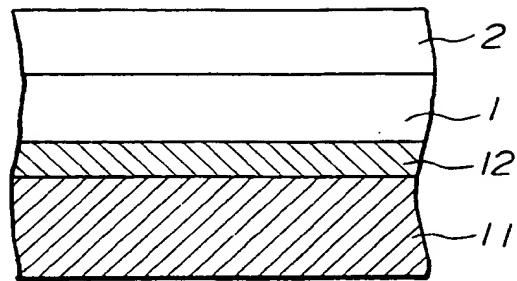


FIG.1B

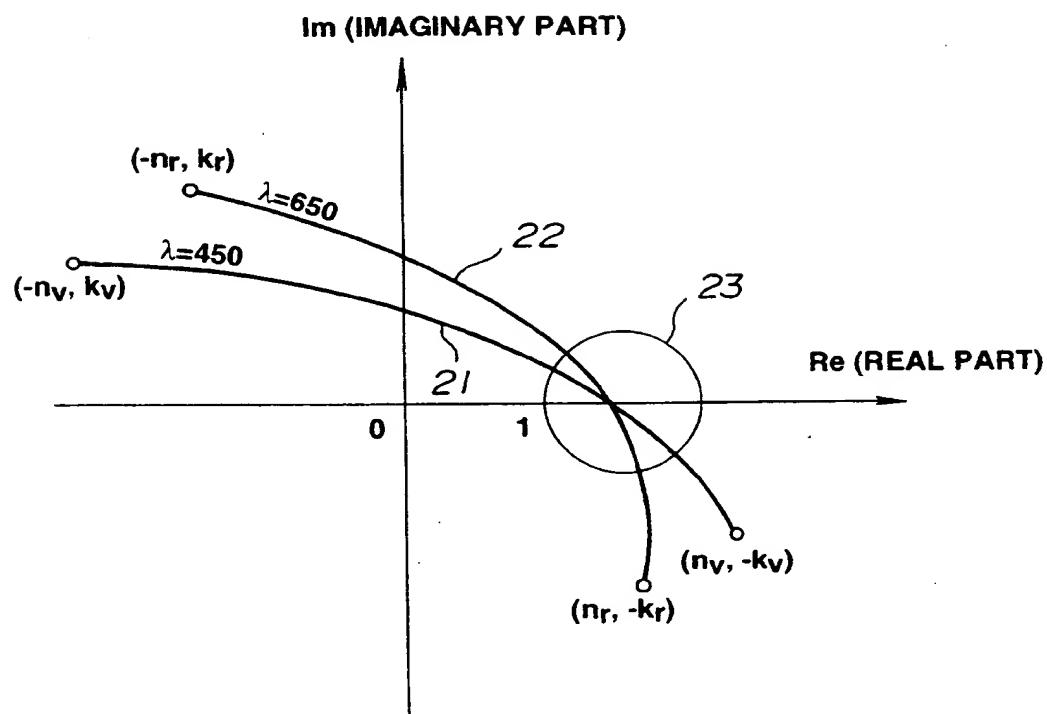


FIG.2

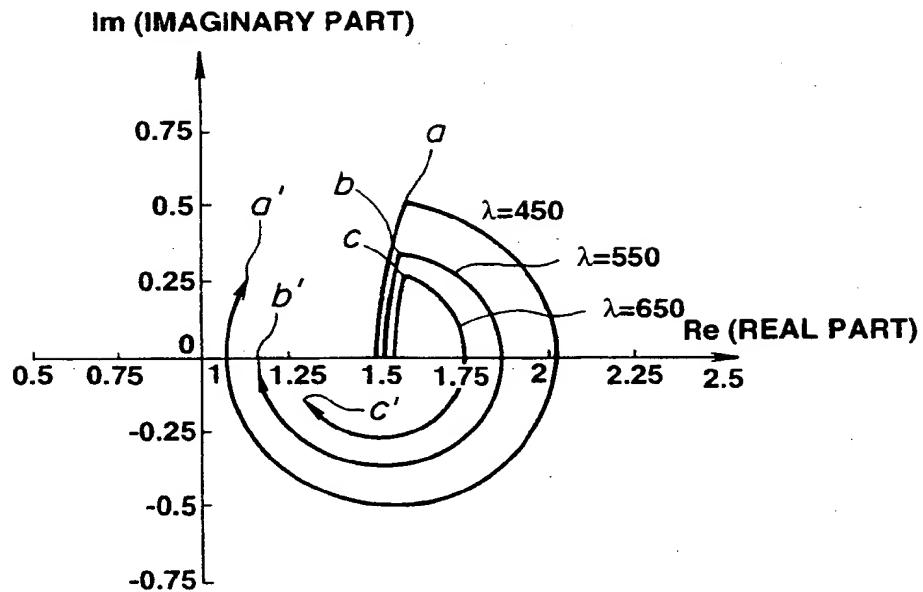


FIG.3

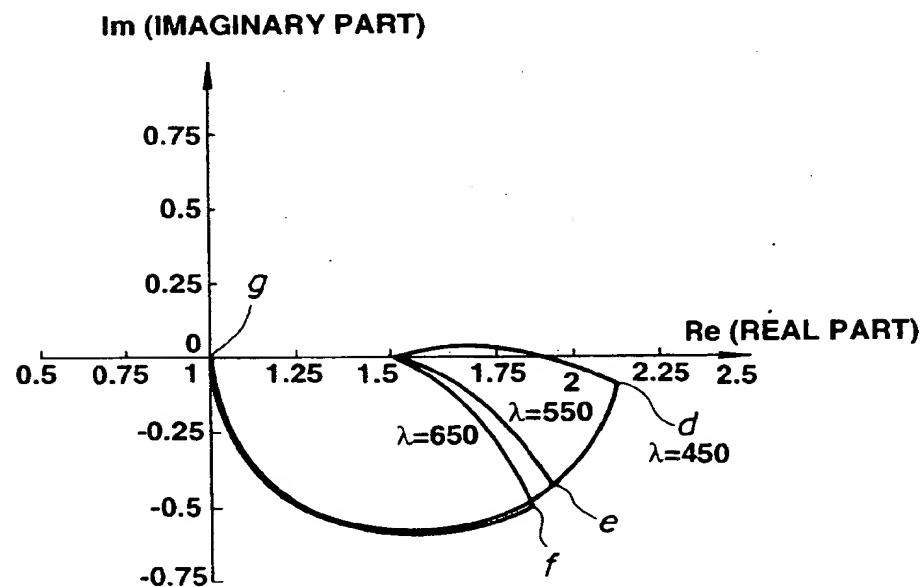


FIG.4

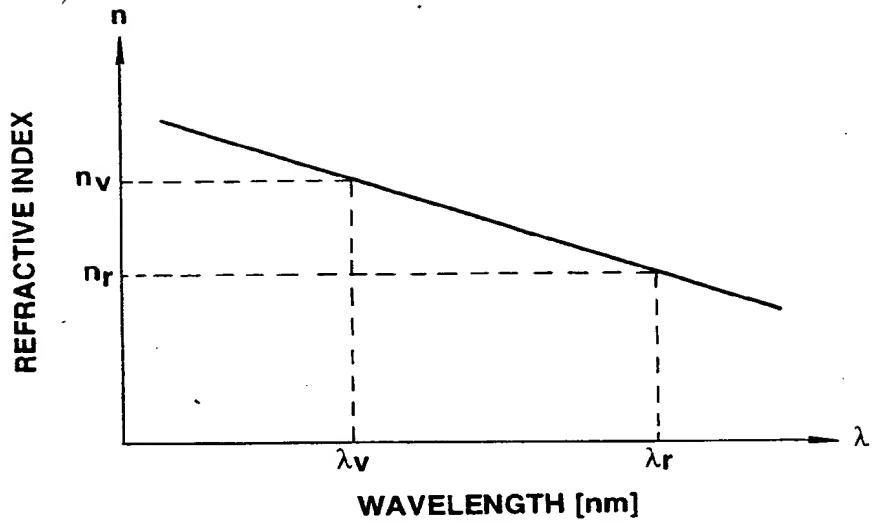


FIG.5A

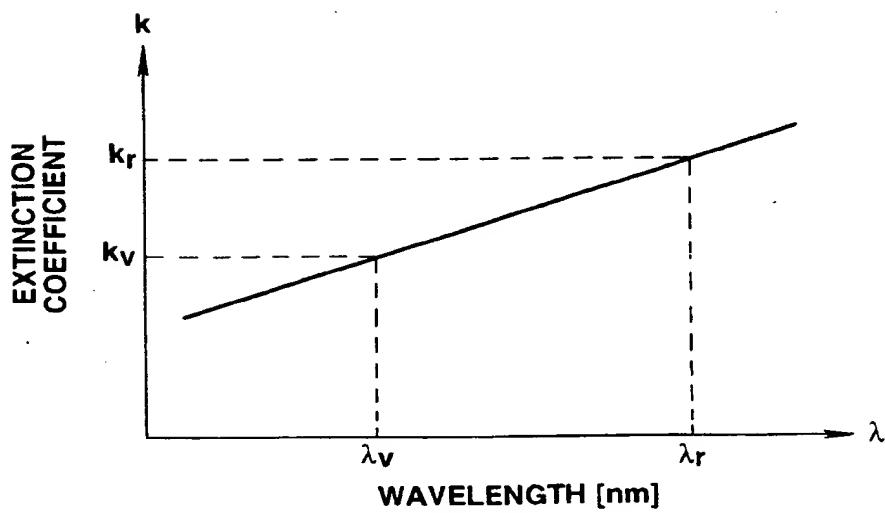


FIG.5B

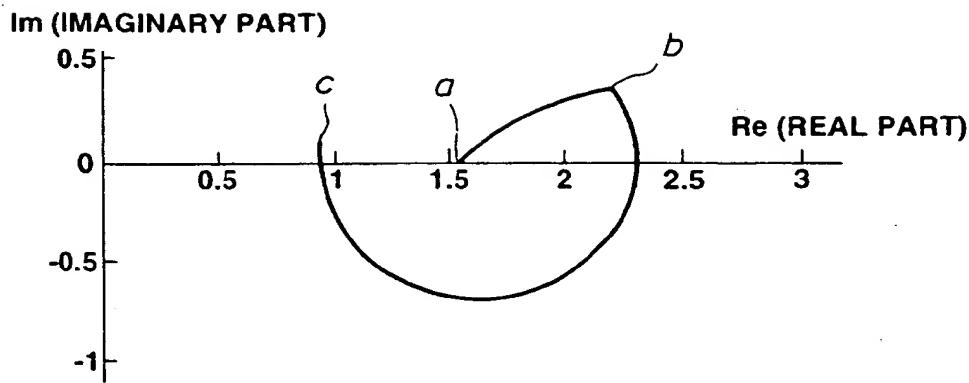


FIG.6

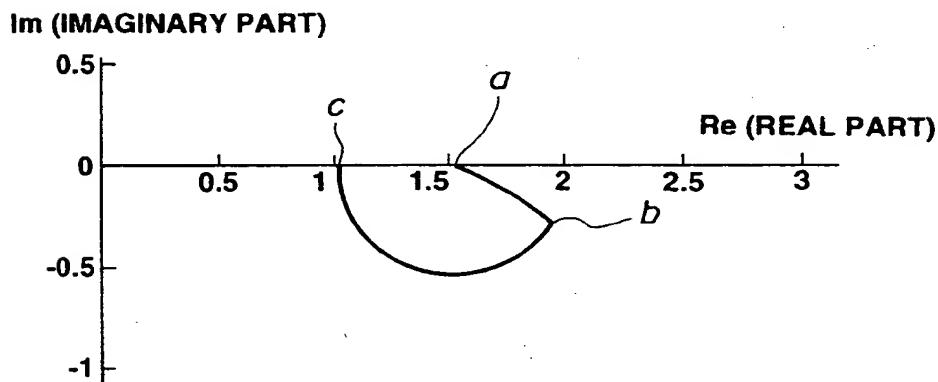


FIG.7

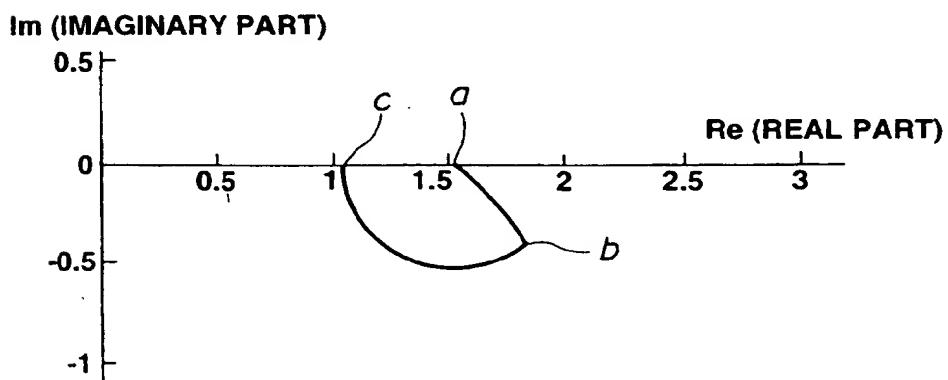


FIG.8

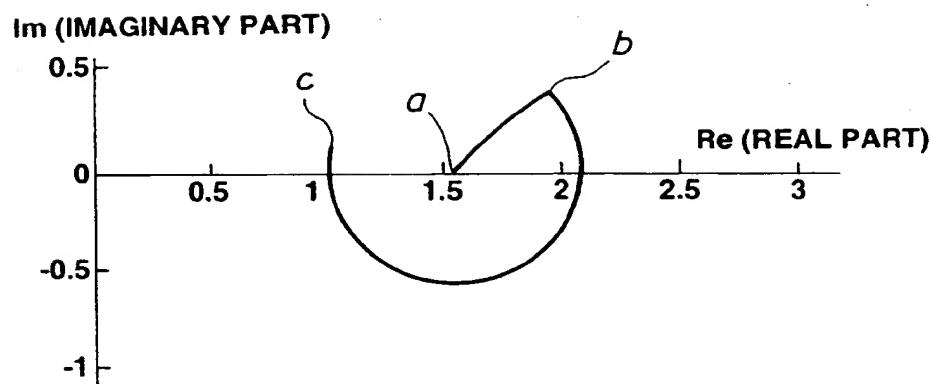


FIG.9

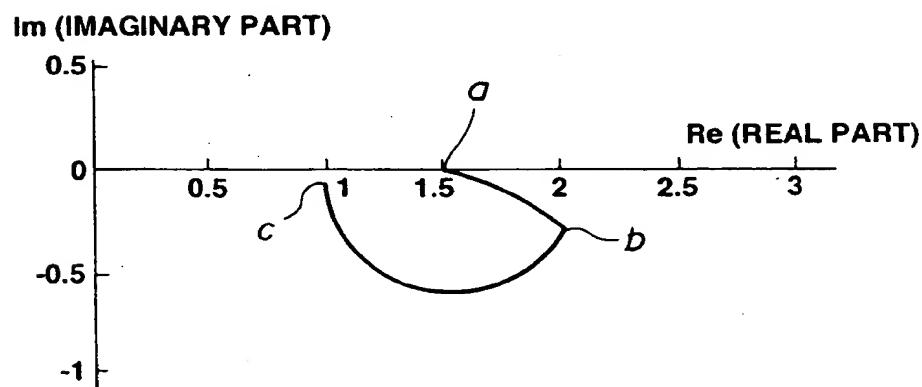


FIG.10

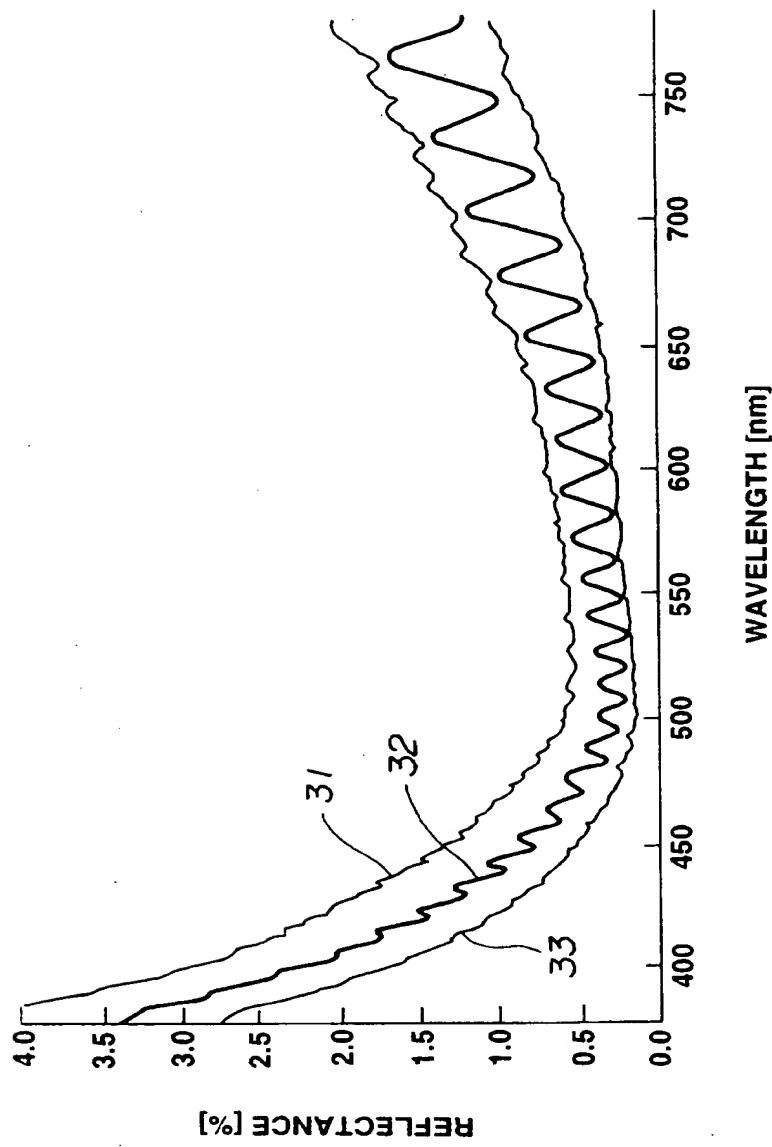


FIG.11

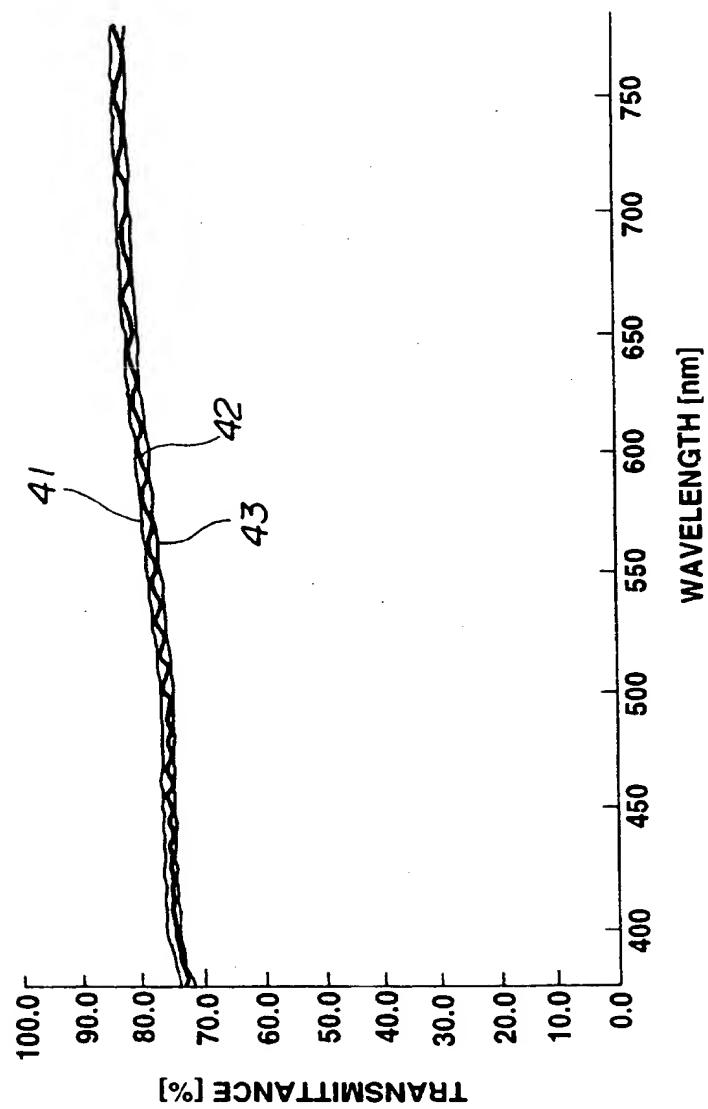


FIG. 12

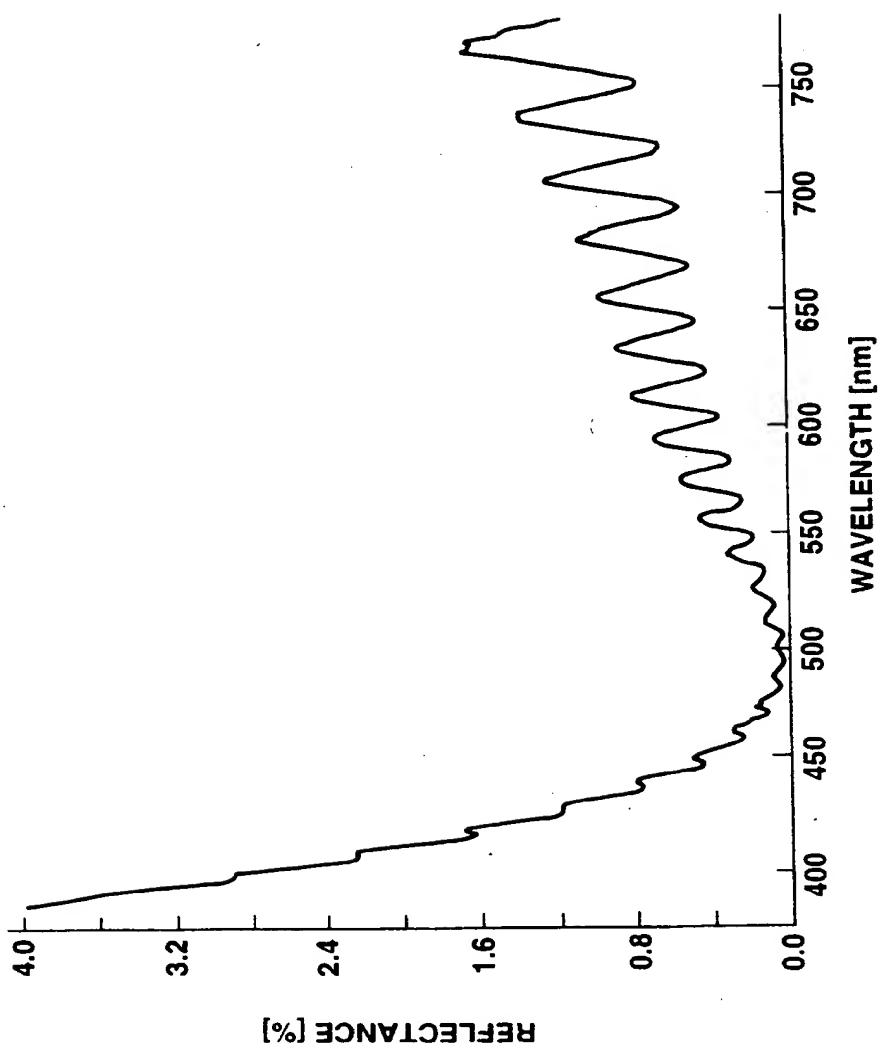


FIG.13

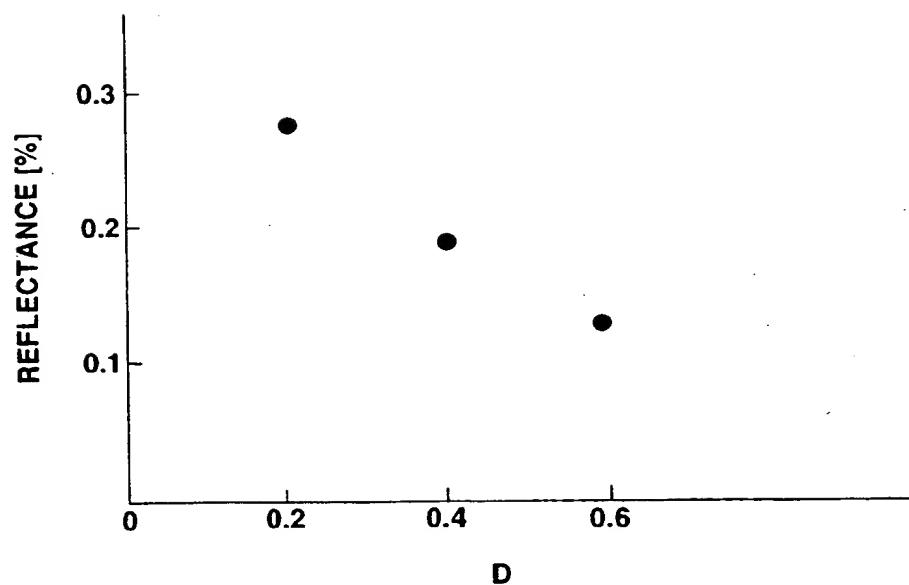


FIG.14

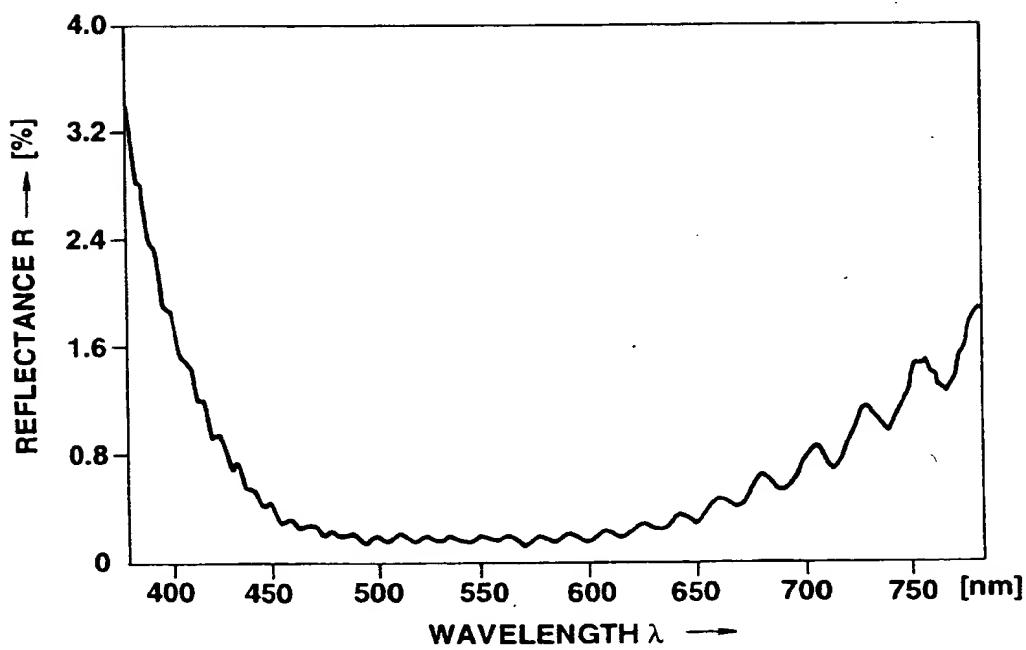


FIG.17

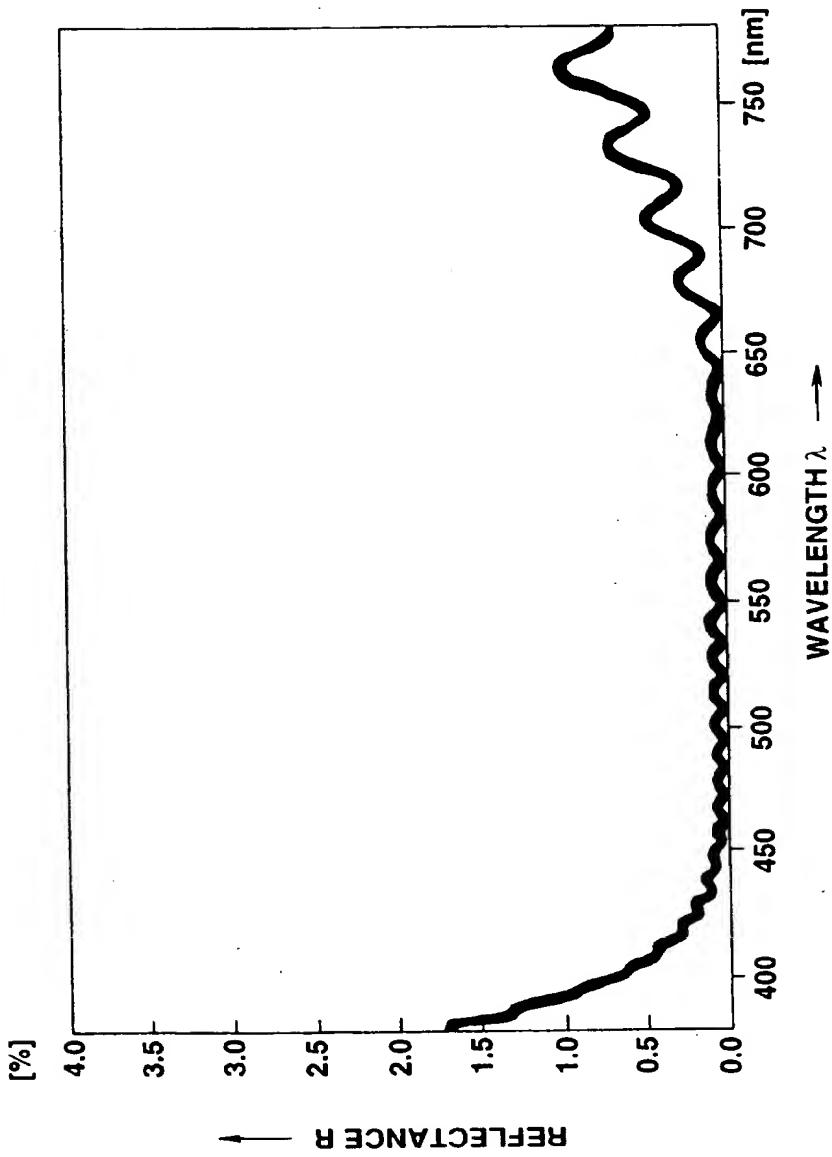


FIG. 15

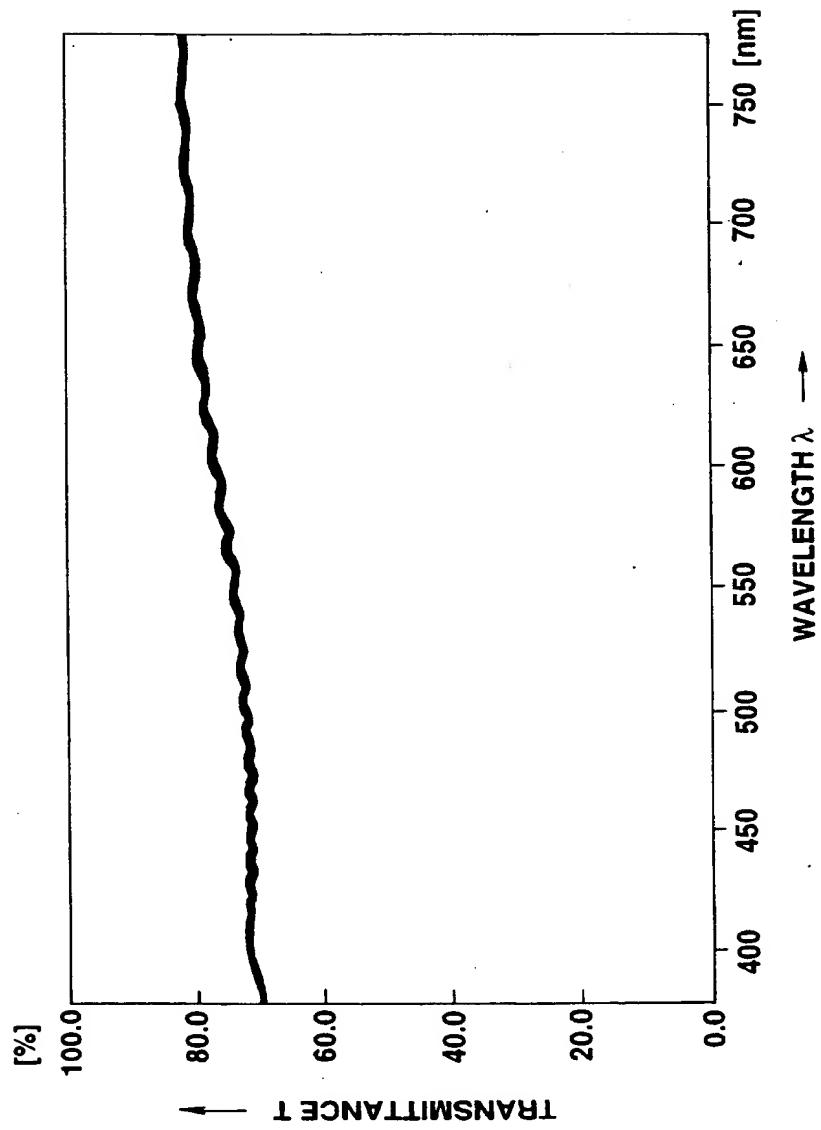


FIG.16

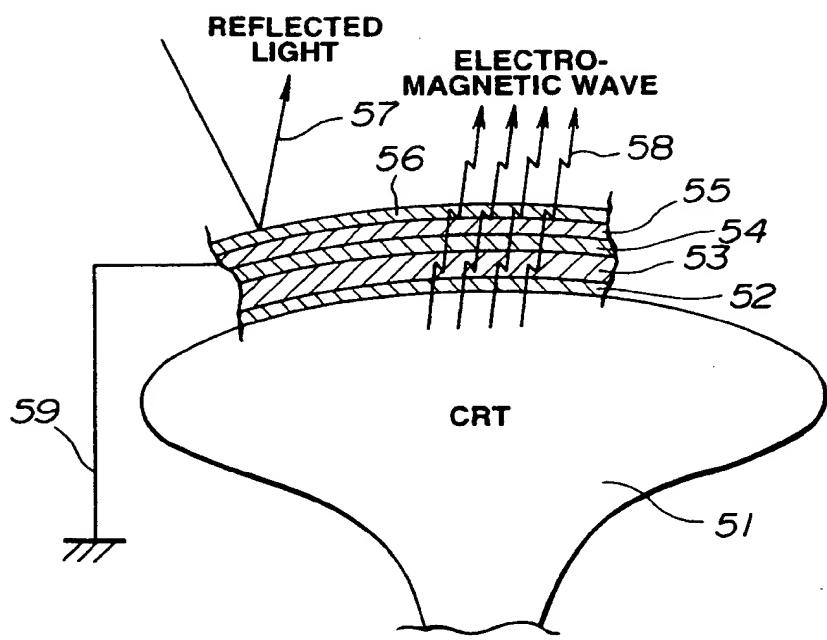


FIG.18



European Patent
Office

EUROPEAN SEARCH REPORT

Application Number
EP 96 11 0847

DOCUMENTS CONSIDERED TO BE RELEVANT			CLASSIFICATION OF THE APPLICATION (Int.Cl.6)
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	
X	US-A-5 091 244 (BIORNARD ERIK J) 25 February 1992 * column 3, line 51 - line 60 * * column 5, line 52 - column 7, line 46 * * column 13, line 25 - line 49 * * figures 3,14,17 * * column 14, line 52 - column 15, line 20 * ---	1,5,6,9, 10	G02B1/10
Y	EP-A-0 564 709 (BALZERS HOCHVAKUUM) 13 October 1993 * page 8, line 24-41 * * page 9, line 1-3 * * page 9, line 27-42; figure 2 * ---	7	
X	US-A-4 264 133 (SAKURAI KUNIO) 28 April 1981 * figure 9 *	1	
X,D	EP-A-0 200 452 (TORAY INDUSTRIES) 5 November 1986 * page 5, line 10-18 * * page 9, line 10 - page 14, line 3 * * page 19, line 10-19 * ---	1-5,9,10	<p>TECHNICAL FIELDS SEARCHED (Int.Cl.6)</p> <p>G02B</p>
Y	US-A-5 190 807 (KIMOCK FRED M ET AL) 2 March 1993 * column 6, line 40-53 *	7	
The present search report has been drawn up for all claims			
Place of search	Date of completion of the search	Examiner	
MUNICH	16 October 1996	Aratari, R	
CATEGORY OF CITED DOCUMENTS		<p>T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document</p>	
X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document			